



Physical Interface & Carriers Japan TC Chapter

Japan Standards Fall 2022 Meetings
September 2
SEMI Japan office, Tokyo, Japan/WEB
13:00-17:00 (JST)

SVM Software (for voting) ※SVM へのログインもお願いします。

1. Open a Web browser and go to: <https://svm.semi.org/> (Do not use Internet Explorer or MS Edge)
2. Click "Login"
3. Enter your Standards Membership username and password (same login for voting on ballots).
1. If you have forgotten your username and/or password, they may be retrieved at: <https://ams.semi.org/ebusiness/ForgotUID.aspx>
2. Find the meeting room: < **Physical Interfaces & Carriers Japan TC Chapter Meeting – May 27,2022**>
3. Click "Go"

AGENDA

1.0 Welcome / Call to Order

- 1.1 Introductions
- 1.2 Meeting Reminders (*Membership Requirement, Antitrust and Intellectual Property Reminders, Effective Meeting Guidelines*)
- 1.3 Agenda Review

2.0 Review of Previous Meeting Minutes

3.0 Liaison Report

- 3.1 North America

4.0 Staff Report

5.0 Ballot Review

- 5.1 None

6.0 Subcommittee & Task Force Reports

- 6.1 300 mm Tape Frame PI&C TF
- 6.2 Global PIC Standards Maintenance TF
- 6.3 Japan Electron Microscopy Workflow liaison TF
- 6.4 Panel Level Packaging Panel FOUP TF
- 6.5 [Liaison: 3D Packaging & Integration JA TC Chapter] Panel Level Packaging Glass Carrier TF
- 6.6 [Liaison: 3D Packaging & Integration NA TC Chapter] Panel Level Packaging Panel TF

7.0 Old Business

- 7.1 Project Period Review
- 7.2 5-Year Review
 - 7.2.1 SEMI E84-1109 (Reapproved 1217): Specification for Enhanced Carrier Handoff Parallel I/O Interface

8.0 New Business

- 8.1 Proposal of New Activity
 - 8.1.1 SNARF Proposal for Reapproval of SEMI E84-1109 (Reapproved 1217) - Specification for Enhanced Carrier Handoff Parallel I/O Interface

9.0 Action Item Review

- 9.1 Open Action Items
- 9.2 New Action Items

10.0 Next Meeting and Adjournment